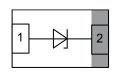


Small Signal Zener Diodes





LINKS TO ADDITIONAL RESOURCES







PRIMARY CHARACTERISTICS									
PARAMETER VALUE UNIT									
V _Z range nom.	4.7 to 47	V							
Test current I _{ZT}	2; 5	mA							
V _Z specification	Pulse current								
Circuit configuration	Single								

FEATURES

- Silicon planar Zener diodes
- · Low leakage current, low noise
- · Excellent stability
- · Surge rated
- ± 2 % Zener voltage tolerance
- Leadless ultra small DFN1006-2A package (1 mm × 0.6 mm × 0.45 mm)
- Power dissipation better than SOT-23
- Surface-mounted device (SMD) plastic package with visible and sidewall plated / wettable flanks



AUTOMOTIVE

- Soldering can be checked by standard visual inspection.
 No X-ray inspection necessary to meet automotive AOI requirements
- AEC-Q101 qualified available
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

ORDERING INFORMATION										
DEVICE NAME	VICE NAME ORDERING CODE AEC-Q101 QUALIFIED TAPED UNITS PER REEL MINIMUM ORDER QUANTI									
D7V004Dyyyl Corion	BZX884Bxxx-G3-08	no	10 000 (9 mm tone on 7" rool)	10 000						
BZX884BxxxL Series	BZX884Bxxx-HG3-08	yes	10 000 (8 mm tape on 7" reel)	10 000						

Note

• xxx stands for any part number/voltage group, as shown in the table of page 2

PACKAGE									
PACKAGE NAME WEIGHT		MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS					
DFN1006-2A	0.83 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	Peak temperature max. 260 °C					

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)									
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT					
Power dissipation	on FR-4 board with recommended soldering footprint	P _{tot}	300	mW					
Non-repetitive peak reverse power	t _p = 100 μs	P _{ZSM}	26	W					
Maximum junction temperature		T _{j max.}	150	°C					
Storage temperature range		T _{stg}	-55 to +150	°C					
Operating temperature range		T _{op}	-55 to +150	°C					

THERMAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)									
PARAMETER TEST CONDITION SYMBOL VALUE UNIT									
Thermal resistance junction to ambient air	according to JEDEC® 51-3 on FR-4 board with recommended soldering footprint	R_{thJA}	420	K/W					
Thermal resistance junction to lead		R_{thJL}	100	K/W					



ELECTRICAL SPECIFICATIONS (T _{amb} = 25 °C, unless otherwise specified)									
PARAMETER TEST CONDITION SYMBOL MAX. UNIT									
Forward voltage	$I_F = 10 \text{ mA}$ V_F 0.9								

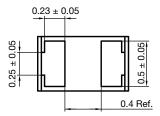
PART NUMBER		ZENER VOLTAGE RANGE ⁽¹⁾ V _Z at I _{ZT1}			TEST CURRENT		REVERSE LEAKAGE CURRENT		DYNAMIC RESISTANCE		TEMPERATURE COEFFICIENT OF ZENER VOLTAGE	
	MARKING CODE				I _{ZT1}	I _{ZT2}	I _R at	t V _R	Z _Z at I _{ZT1}	Z _{ZK} at I _{ZT2}	α _{VZ} a	at I _{ZT1}
		V		mA		μΑ	μA V		Ω		10 ⁻⁴ /°C	
		MIN.	NOM.	MAX.			MAX.		MAX.	MAX.	MIN.	MAX.
BZX884B4V7L	AK	4.61	4.7	4.79	5	1	3	2	80	500	-5	2
BZX884B5V1L	AL	5	5.1	5.2	5	1	2	2	60	480	-3	4
BZX884B5V6L	AN	5.49	5.6	5.71	5	1	1	2	40	400	-2	6
BZX884B6V2L	AO	6.08	6.2	6.32	5	1	3	4	10	150	-1	7
BZX884B6V8L	AP	6.66	6.8	6.94	5	1	2	4	15	80	2	7
BZX884B7V5L	AR	7.35	7.5	7.65	5	1	1	5	15	80	3	7
BZX884B8V2L	AS	8.04	8.2	8.36	5	1	0.7	5	15	80	4	7
BZX884B9V1L	AT	8.92	9.1	9.28	5	1	0.5	6	15	100	5	8
BZX884B10L	AU	9.8	10	10.2	5	1	0.2	7	20	150	5	8
BZX884B11L	AV	10.78	11	11.22	5	1	0.1	8	20	150	5	9
BZX884B12L	AX	11.76	12	12.24	5	1	0.1	8	25	150	6	9
BZX884B13L	AY	12.74	13	13.26	5	1	0.1	8	30	170	7	9
BZX884B15L	A2	14.7	15	15.3	5	1	0.05	10.5	30	200	7	9
BZX884B16L	A3	15.68	16	16.32	5	1	0.05	11.2	40	200	8	9.5
BZX884B18L	A4	17.64	18	18.36	5	1	0.05	12.6	45	225	8	10
BZX884B20L	A5	19.6	20	20.4	5	1	0.05	14	55	225	8	10
BZX884B22L	B5	21.56	22	22.44	5	1	0.05	15.4	55	250	8	10
BZX884B24L	A7	23.52	24	24.48	5	1	0.05	16.8	70	250	8	10
BZX884B27L	A9	26.46	27	27.54	2	0.5	0.05	18.9	80	300	8	10
BZX884B30L	BA	29.4	30	39.8	2	0.5	0.05	21	80	300	8	10
BZX884B33L	BB	32.34	33	33.66	2	0.5	0.05	23.1	80	325	8	10
BZX884B36L	BC	35.28	36	36.72	2	0.5	0.05	25.2	90	350	8	10
BZX884B39L	BD	38.22	39	39.78	2	0.5	0.05	27.3	130	350	10	12
BZX884B43L	BE	42.14	43	43.86	2	35	0.05	30.1	150	375	10	12
BZX884B47L	BG	46.06	47	47.94	2	0.5	0.05	32.9	170	375	10	12

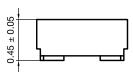
Notes

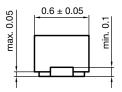
⁽¹⁾ Pulse test $t_p = 5 \text{ ms}$

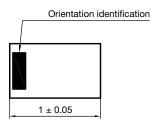


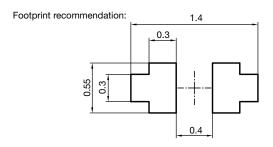
PACKAGE DIMENSIONS in millimeters: DFN1006-2A







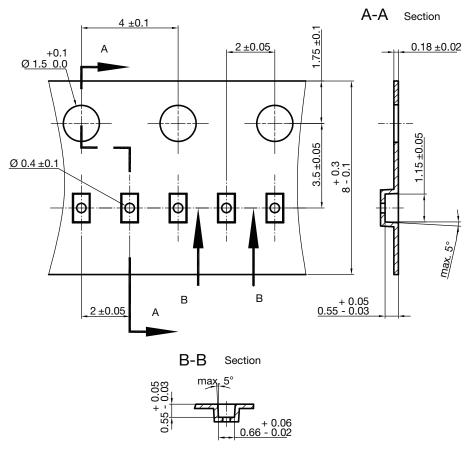




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CARRIER TAPE DFN1006-2A



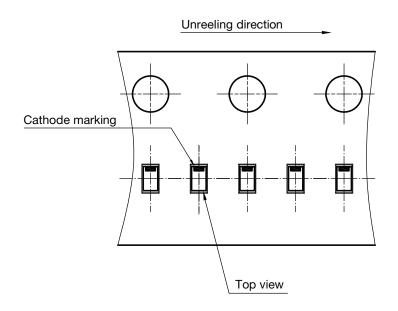
S8-V-3906.04-063 (4) created 28.10.2019

S8-V-3906.04-064 (4)

created 28.10.2019

surface resistance: 10^5 - $10^{11} \frac{OHMS}{SQ}$ Cummulative tolerances of 10 sprocket holes is ± 0.2 mm

ORIENTATION IN CARRIER TAPE DFN1006-2A





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